



**SEMIPACK® 1**

## Rectifier Diode Modules

### SKKD 75/16

#### Features\*

- Heat transfer through aluminium oxide ceramic insulated metal baseplate
- UL recognized, file no. E63532

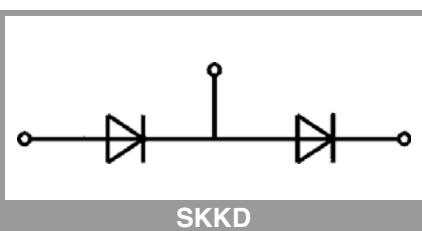
#### Typical Applications

- Non-controllable rectifiers for AC/AC converters
- Line rectifiers for transistorized AC motor controllers
- Field supply for DC motors

Absolute Maximum Ratings		Values		Unit
Symbol	Conditions			
<b>Rectifier Diode</b>				
$I_{F\text{AV}}$	sin. 180° $T_{j\text{ max}} = 130^\circ\text{C}$	$T_c = 85^\circ\text{C}$ $T_c = 100^\circ\text{C}$	75 57	A A
$I_{F\text{SM}}$	$t_p = 10 \text{ ms}$	$T_j = 25^\circ\text{C}$ $T_j = 130^\circ\text{C}$	1700 1450	A A
$i^2t$	$t_p = 10 \text{ ms}$	$T_j = 25^\circ\text{C}$ $T_j = 130^\circ\text{C}$	14450 10513	$\text{A}^2\text{s}$ $\text{A}^2\text{s}$
$V_{R\text{SM}}$	$T_j = 25^\circ\text{C}$		1700	V
$V_{R\text{RM}}$	$T_j = 25^\circ\text{C}$		1600	V
$T_j$			-40 ... 130	$^\circ\text{C}$
<b>Module</b>				
$T_{\text{stg}}$			-40 ... 125	$^\circ\text{C}$
$V_{\text{isol}}$	a.c.; 50 Hz; r.m.s.	1 min 1 s	3000 3600	V V

#### Characteristics

Symbol	Conditions	min.	typ.	max.	Unit
<b>Diode</b>					
$V_F$	$T_j = 25^\circ\text{C}, I_F = 225 \text{ A}$			1.65	V
$V_{F0}$	$T_j = 130^\circ\text{C}$			0.85	V
$r_F$	$T_j = 130^\circ\text{C}$			3.90	$\text{m}\Omega$
$I_R$	$T_j = 130^\circ\text{C}, V_{RD} = V_{RRM}$			1.7	mA
$R_{\text{th(j-c)}}$	cont.	per chip per module		0.3 0.15	K/W
$R_{\text{th(j-c)}}$	sin. 180°	per chip per module		0.38 0.19	K/W
<b>Module</b>					
$R_{\text{th(c-s)}}$	per chip ( $\lambda_{\text{grease}} = 0.81 \text{ W}/(\text{m}^*\text{K})$ ) per module ( $\lambda_{\text{grease}} = 0.81 \text{ W}/(\text{m}^*\text{K})$ )		0.09 0.05		K/W
$M_s$	to heatsink M5		4.25	5.75	Nm
$M_t$	to terminals M5		2.55	3.45	Nm
$a$				5 * 9.81	$\text{m}/\text{s}^2$
$w$			75		g



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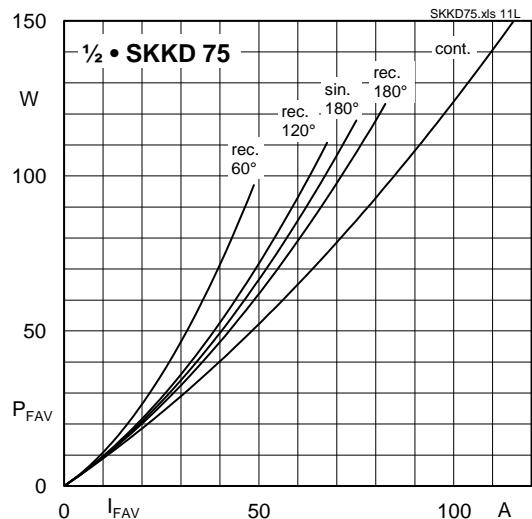


Fig. 11L: Power dissipation per diode vs. forward current

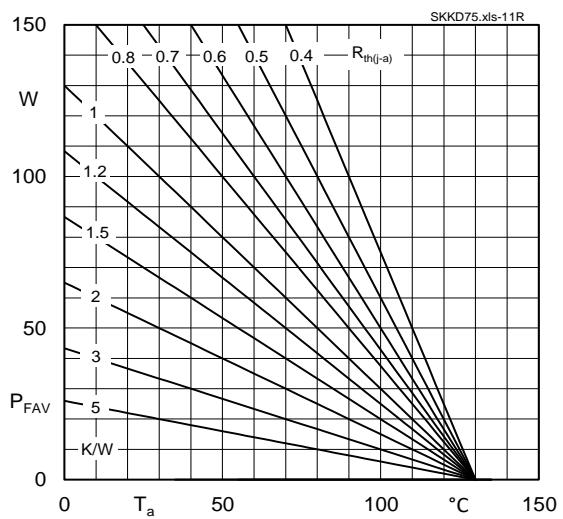


Fig. 11R: Power dissipation per diode vs. ambient temperature

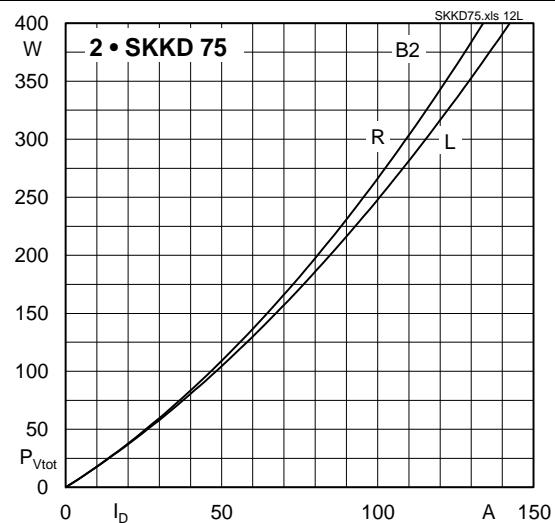


Fig. 12L: Power dissipation of two modules vs. direct current

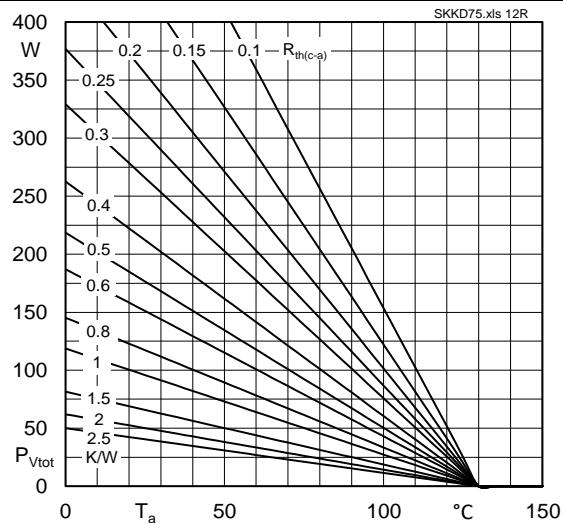


Fig. 12R: Power dissipation of two modules vs. ambient temperature

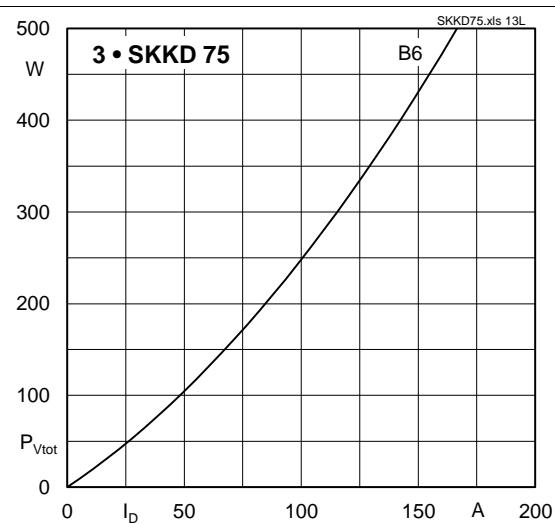


Fig. 13L: Power dissipation of three modules vs. direct current

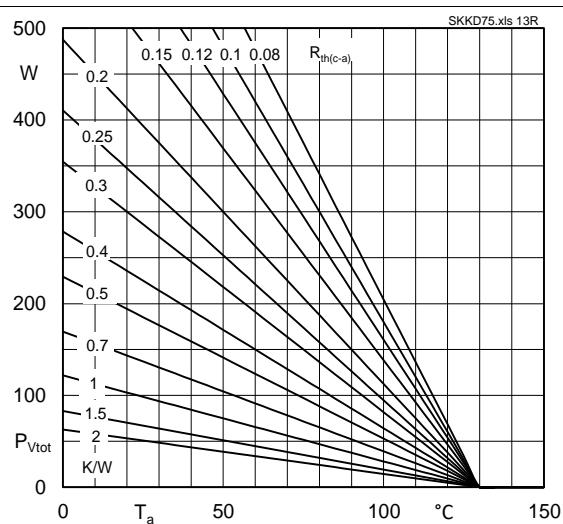


Fig. 13R: Power dissipation of three modules vs. ambient temperature

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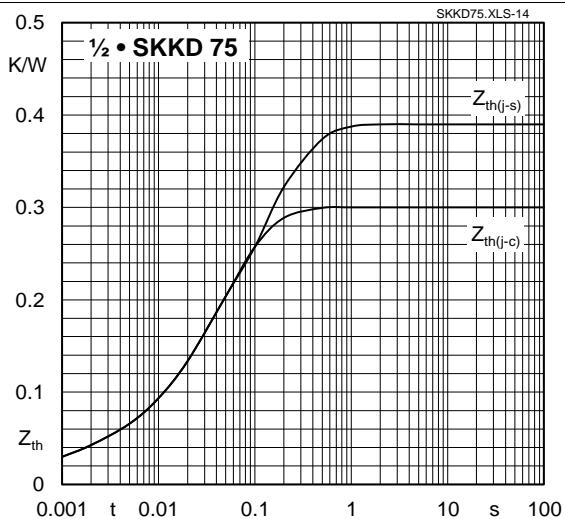


Fig. 14: Transient thermal impedance vs. time

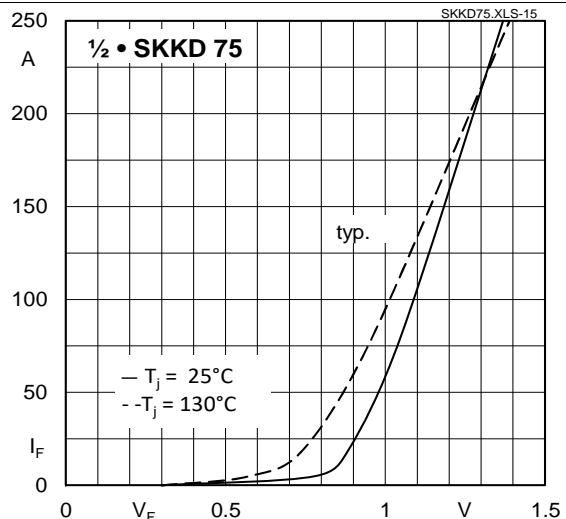


Fig. 15: Forward characteristics

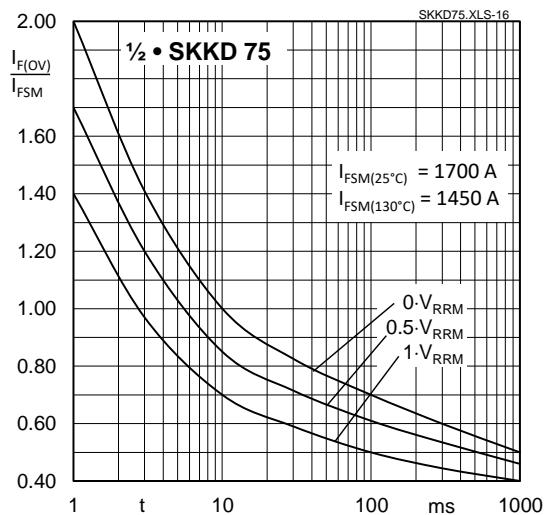
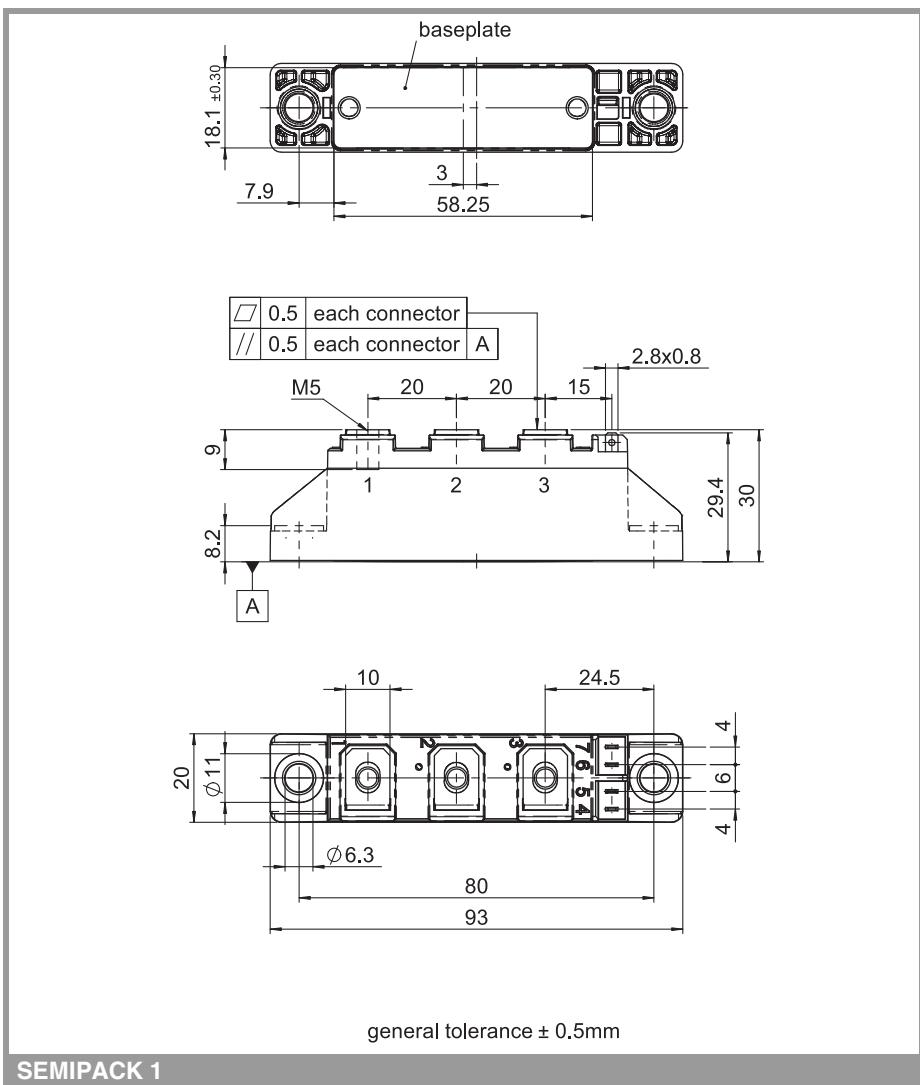


Fig. 16: Surge overload current vs. time



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## IMPORTANT INFORMATION AND WARNINGS

This is an electrostatic discharge sensitive device (ESDS) according to international standard IEC 61340.

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